PCN Number:			20220915000.1						PCN Date:		Septemb 2022	er 15,
Title:												
Customer Contact:			PCN Manager D				<b>Dept:</b> Quali			ity Services		
Proposed 1 <sup>st</sup> Ship Date:			Dec 15, 2022			Sample requaccepted un			•	L C)CT		2022*
*Sample requ	uests received	after (C	ct 15 <sup>tl</sup>	<sup>h</sup> , 202	22) will	not be	supp	orted.				
Change Type					_							
Asseml					esign			Wafer Bump Site				
Assembly Process						Data Sheet			ឣ	Wafer Bump Material		
Assembly Materials  Machanical Specification						art number change est Site			<u> </u>	☐ Wafer Bump Process☐ Wafer Fab Site		
<ul><li>Mechanical Specification</li><li>Packing/Shipping/Labelii</li></ul>			Test Process			S		$\overline{H}$	Wafer Fab Materials			
			g						Wafer Fab Process			
PCN Details												
Description of Change:												
Texas Instruments is pleased to announce the qualification of new assembly material for devices listed in "Product affected" section below. Devices will remain in current assembly facility and piece part changes as follows:												
Material			Current				Pr			oposed		
Wire type			0.96 mil <i>i</i>			١u	1.0			0 mil Cu		
Reason for Change:												
Continuity of	supply.											
1) To align w	ith world tech	nology t	rends	and ι	use wir	ing wit	h enh	nanced r	necl	nanical ar	nd	
electrical	properties											
2) Maximize	flexibility with	in our A	ssemb	ly/Te	st prod	duction	sites					
3) Cu is easi	er to obtain ar	nd stock										
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):												
None.												
Impact on E	nvironmenta	l Rating	gs									
Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.												
	RoHS		REACH			Green Status			IEC 62474			
⊠ No C	hange	⊠ No	☑ No Change				nge		⊠ No C	hange		
Changes to product identification resulting from this PCN:												
None.												
Product Affected:												
PCM1681PWP PCM1690DCA PCM1789PW												
PCM1681PW		.690DCAR PCM1789PWR										
PCMITOOILMLK LCMITOANDCAK LCMI1/QALMK												

## Qualification Report Approve Date 17-AUGUST -2022

## **Qualification Results**

Data Displayed as: Number of lots / Total sample size / Total failed

		L	рака Бізріаує	eu as: Nu	imber of lots /	rotarsample size /	Total falled	
Туре	#	Test Name	Condition	Duration	Qual Device: PCM1690DCAR	QBS Reference: PCM3168ATPAPRQ1	QBS Reference: PCM1753TDBQRQ1	QBS Reference: TPS653853QDCARQ1
HAST	A2	Biased HAST	130C/85%RH	96 Hours	-	-	3/231/0	3/231/0
UHAST	А3	Autoclave	121C/15psig	96 Hours	1/77	-	-	-
UHAST	А3	Autoclave	121C/15psig	96 Hours	-	2/154/0	3/225/0 <sup>1</sup>	3/231/0
TC	A4	Temperature Cycle	-65C/150C	500 Cycles	1/77	-	-	-
TC	A4	Temperature Cycle	-65C/150C	500 Cycles	-	3/231/0	3/231/0	3/231/0
HTSL	A6	High Temperature Storage Life	150C	1000 Hours	1/77	-	-	-
HTSL	A6	High Temperature Storage Life	150C	500 Hours	-	-	1/45/0	-
HTOL	B1	Life Test	105C	1000 Hours	-	3/230/1 <sup>2</sup>	-	-
HTOL	B1	Life Test	105C	480 Hours	-	-	3/231/0	-
HTOL	B1	Life Test	125C	1000 Hours	-	-	-	3/231/0
ELFR	B2	Early Life Failure Rate	125C	24 Hours	-	3/2400/2 <sup>3</sup>	-	-
ELFR	B2	Early Life Failure Rate	125C	48 Hours	-	-	-	3/2400/0
ESD	E2	ESD CDM	-	250 Volts	-	-	-	-
ESD	E2	ESD CDM	-	500 Volts	-	3/9/0	3/9/0	1/3/0
ESD	E2	ESD HBM	-	1000 Volts	-	-	-	-
ESD	E2	ESD HBM	-	2000 Volts	-	-	-	1/3/0
ESD	E2	ESD HBM	-	2500 Volts	-	3/9/0	3/9/0	-
LU	E4	Latch-Up	Per JESD78	-	-	-	-	-
CHAR	E5	Electrical Characterization	Min, Typ, Max Temp	-	1/30	-	-	-
CHAR	E5	Electrical Distributions	Cpk>1.67 Room, hot, and cold	-	-	3/90/0	3/90/0	3/90/0

QBS: Qual By Similarity

Qual Device PCM1690DCAR is qualified at MSL3 260C

Qual Device PCM1690DCA is qualified at MSL3 260C

Qual Device PCM1681PWP is qualified at MSL3 260C

Qual Device PCM1681PWPR is qualified at MSL3 260C

Qual Device PCM1789PW is qualified at MSL2 260C

Qual Device PCM1789PWR is qualified at MSL2 260C

Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours

The following are equivalent Temp Cycle options per JESD47: -55C/125C/700 Cycles and -65C/150C/500 Cycles Quality and Environmental data is available at Tl's external Web site: http://www.ti.com/ Green/Pb-free Status:

Note: This qualification memo also covers the PCM1681PWPRG4 and PCM1789PWRG4 devices.

Qualified Pb-Free (SMT) and Green

- [1]-Short 5 units due to mechanical damage.
- [2]-The fail mode seen in the F/A is the same one that is seen in ELFR on this device. No Corrective action. Automotive devices will continue performing burn-in in production.
- [3]-(QTS380501-1) Ti partide found in unit 1. Corrective actions implemented. Unit 2 fail mechanism not found

For questions regarding this notice, e-mails can be sent to the contact shown below or your local Field Sales Representative.

Location	E-Mail				
WW Change Management Team	PCN ww admin team@list.ti.com				

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